www.ti.com

WIDEBAND, LOW NOISE, LOW DISTORTION FULLY DIFFERENTIAL AMPLIFIER WITH RAIL-TO-RAIL OUTPUTS

FEATURES

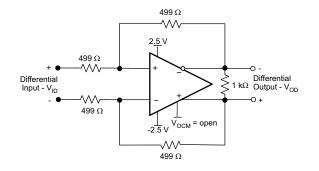
- Fully Differential Architecture With Rail-to-Rail
- **Centered Input Common-mode Range**
- Minimum Gain of 1 V/V (0 dB)
- Bandwidth: 620 MHz Slew Rate: 570 V/us 0.1% Settling Time: 7 ns
- HD_2 : -115 dBc at 100 kHz, V_{OD} = 8 V_{PP} HD_3 : -123 dBc at 100 kHz, V_{OD} = 8 V_{PP} Input Voltage Noise: 2 nV/√Hz (f >10 kHz)
- **Output Common-Mode Control**
- **Power Supply:**
 - Voltage: 3.3 V (±1.65 V) to 5 V (±2.5 V)
 - Current: 14.2 mA
- Power-Down Capability: 15 µA

APPLICATIONS

- 5-V and 3.3-V Data Acquisition Systems
- **High Linearity ADC Amplifier**
- **Wireless Communication**
- **Test and Measurement**
- **Voice Processing Systems**

RELATED PRODUCTS

| Device | BW (MHZ) | Slew Rate (V/µsec) | | |
|---------|-------------|-----------------------|----------------|-----|
| THS4509 | 2000 | 6600 | -102 at 10 MHz | 1.9 |
| THS4500 | 370 | 2800 | -82 at 8 MHz | 7 |
| THS4130 | 150 | 52 | -97 at 250 kHz | 1.3 |



DESCRIPTION

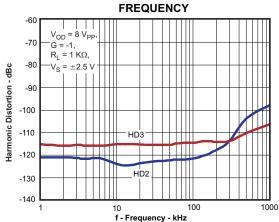
The THS4520 is a wideband, fully differential operational amplifier designed for 5-V acquisition systems. It has very low noise at 2 nV/ $\sqrt{\text{Hz}}$, and low harmonic distortion of -115 dBc HD_2 and -123 dBc HD_3 at 100 kHz with 8 V_{PP} , and $1-k\Omega$ load. The slew rate is 570 V/µs, and with a settling time of 7 ns to 0.1% (2-V step), it is ideal for data acquisition applications. It is designed for unity gain stability.

To allow for dc coupling to ADCs, its unique output common-mode control circuit maintains the output common-mode voltage within 0.25 mV offset (typical) from the set voltage. The common-mode set point defaults to mid-supply by internal circuitry, which may be over-driven from an external source.

The input and output are optimized for best performance with their common-mode voltages set to mid-supply. Along with high performance at low power supply voltage, this makes for extremely high performance single supply 5-V and 3.3-V data acquisition systems.

The THS4520 is offered in a Quad 16-pin leadless QFN package (RGT), and is characterized for operation over the full industrial temperature range from -40°C to 85°C.





Measured HD2/HD3 for G = -1, $V_{OD} = 8$ V_{PP} , $R_L = 1 \text{ K}\Omega$ (circuit shown on the left)

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Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)

| | | | UNIT |
|------------------------------------|------------------|--|------------------------------|
| V _{S-} to V _{S+} | Supply voltage | 9 | 6 V |
| VI | Input voltage | | ±V _S |
| V _{ID} | Differential inp | out voltage | 4 V |
| Io | Output current | t ⁽¹⁾ | 200 mA |
| | Continuous po | ower dissipation | See Dissipation Rating Table |
| _ | Maximum juno | ction temperature | 150°C |
| IJ | Maximum juno | ction temperature, continuous operation, long term reliability | 125°C |
| T _A | Operating free | e-air temperature range | −40°C to 85°C |
| T _{stg} | Storage tempe | erature range | -65°C to 150°C |
| | Lead tempera | ture 1,6 mm (1/16 inch) from case for 10 seconds | 300°C |
| | | НВМ | 2000 |
| | ESD ratings | CDM | 1500 |
| | | MM | 100 |

⁽¹⁾ The THS4520 incorporates a (QFN) exposed thermal pad on the underside of the chip. See TI technical brief SLMA002 and SLMA004 for more information about utilizing the QFN thermally enhanced package.

DISSIPATION RATINGS TABLE PER PACKAGE

| PACKAGE ⁽¹⁾ | Δ Δ | | POWER RATING | | | |
|------------------------|------------------|----------|-----------------------|-----------------------|--|--|
| FACRAGE | ₽ ¹ C | DJA | $T_A \le 25^{\circ}C$ | T _A = 85°C | | |
| RGT (16) | 2.4°C/W | 39.5°C/W | 2.3 W | 225 mW | | |

⁽¹⁾ For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI Web site at www.ti.com.



DEVICE INFORMATION

RGT Package (TOP VIEW) V_{S-} NC $\overline{\mathsf{PD}}$ 12 □ 11 □ $V_{\text{IN+}}$ V_{OUT+} $V_{\text{OUT-}}$ CM СМ 9 🗆 6 7 8 5

TERMINAL FUNCTIONS

 $V_{\text{S+}}$

| TERMINAL (RGT PACKAGE) | | DESCRIPTION | | | | |
|---------------------------|-------------------|---|--|--|--|--|
| NO. | NAME | | | | | |
| 1 | NC | No internal connection | | | | |
| 2 | V_{IN-} | Inverting amplifier input | | | | |
| 3 | V _{OUT+} | Non-inverted amplifier output | | | | |
| 4, 9 | CM | Common-mode voltage input | | | | |
| 5, 6, 7, 8 | V _{S+} | Positive amplifier power supply input | | | | |
| 10 | V _{OUT} | Inverted amplifier output | | | | |
| 11 | V_{IN+} | Non-inverting amplifier input | | | | |
| 12 | PD | Powerdown, \overline{PD} = logic low puts part into low power mode, \overline{PD} = logic high or open for normal operation. If the PD pin is open (unterminated) the device will default to the enabled state. | | | | |
| 13, 14, 15, 16 | V _{S-} | Negative amplifier power supply input | | | | |



SPECIFICATIONS; $V_{S+} - V_{S-} = 5 \text{ V}$:

Test conditions unless otherwise noted: V_{S+} = +2.5 V, V_{S-} = -2.5 V, G = 0 dB, CM = open, V_O = 2 V_{PP} , R_F = 499 Ω , R_L = 200 Ω Differential, T_A = 25°C Single-Ended Input, Differential Output, Input and Output Referenced to mid-supply

| PARAMETER | TEST CONDITIONS | | | MIN | TYP | MAX | UNIT | TEST LEVEL ⁽¹⁾ |
|--|--|---|---|-----|------|-----|--------------------|------------------------------|
| AC PERFORMANCE | | | | | | | | |
| | $G = 0 dB, V_O = 1$ | $G = 0 \text{ dB}, V_O = 100 \text{ mV}_{PP}$ | | | 620 | | MHz | |
| Consul Circust Barreloids | $G = 6 \text{ dB}, V_0 = 1$ | G = 6 dB, V _O = 100 mV _{PP} | | | 450 | | MHz | |
| Small-Signal Bandwidth | $G = 10 dB, V_O =$ | 100 mV _{PP} | | | 330 | | MHz | |
| | $G = 20 dB, V_O =$ | 100 mV _{PP} | | | 120 | | MHz | С |
| Gain-Bandwidth Product | G = 20 dB | | | | 1200 | | MHz | |
| Bandwidth for 0.1 dB flatness | $G = 6 \text{ dB}, V_O = 2$ | 2 V _{PP} | | | 30 | | MHz | |
| Large-Signal Bandwidth | $G = 6 \text{ dB}, V_0 = 2$ | 2 V _{PP} | | | 132 | | MHz | |
| Slew Rate (Differential) | | | | | 570 | | V/µs | |
| Rise Time | | | | | 4 | | | |
| Fall Time | 2-V Step | | | | 4 | | ns | С |
| Settling Time to 1% | | | | | 6.2 | | 115 | |
| Settling Time to 0.1% | | | | | 7 | | | |
| | f = 100 kHz ⁽³⁾ | $R_L = 1 k\Omega$ | $V_{OD} = 8 V_{PP}$ | | -115 | | | |
| | | R _L = 200 | $V_{OD} = 2 V_{PP}$ | | -100 | | dBc | |
| | f = 1 MHz ⁽⁴⁾ | Ω | $V_{OD} = 4 V_{PP}$ | | -93 | | | |
| | | $R_L = 1 k\Omega$ | $V_{OD} = 2 V_{PP}$ | | -101 | | | |
| 2 nd Order Harmonic Distortion ⁽²⁾ | | | $V_{OD} = 4 V_{PP}$ | | -101 | | | С |
| | f = 8 MHz ⁽⁴⁾ | R _L = 200 Ω | $V_{OD} = 2 V_{PP}$ | | -103 | | | |
| | | | $V_{OD} = 4 V_{PP}$ | | -97 | | | |
| | | $R_L = 1 k\Omega$ | $V_{OD} = 2 V_{PP}$ | | -100 | | | |
| | | | $V_{OD} = 4 V_{PP}$ | | -95 | | | |
| | f = 100 kHz ⁽³⁾ | $R_L = 1 k\Omega$ | $V_{OD} = 8 V_{PP}$ | | -123 | | | |
| | | R _L = 200 Ω | $V_{OD} = 2 V_{PP}$ | | -105 | | | |
| | (4) | | $V_{OD} = 4 V_{PP}$ | | -93 | | | |
| | f = 1 MHz ⁽⁴⁾ | | $V_{OD} = 2 V_{PP}$ | | -101 | | | |
| 3 rd Order Harmonic Distortion ⁽²⁾ | | $R_L = 1 k\Omega$ | $V_{OD} = 4 V_{PP}$ | | -96 | | dBc | С |
| | | R ₁ = 200 | $V_{OD} = 2 V_{PP}$ | | -92 | | | |
| | (4) | Ω | Van - 4 Van | | -88 | | | |
| | f = 8 MHz ⁽⁴⁾ | D 410 | $V_{OD} = 4 V_{PP}$ $V_{OD} = 4 V_{PP}$ | | -102 | | | |
| | | $R_L = 1 \text{ K}\Omega$ | $V_{OD} = 4 V_{PP}$ | | -91 | | | |
| | $f_{C} = 100 \text{ kHz}^{(3)},$ $R_{L} = 1 \text{ k} \Omega, V_{OD} =$ | f_C = 100 kHz $^{(3)}$, 10-kHz Tone Spacing, R_L = 1k Ω , V_{OD} = 8 V_{PP} envelope, G = 0dB | | | -135 | | dBc | С |
| 3 rd Order Intermodulation Distortion | $f_{C} = 1 \text{ MHz}^{(4)}, 10$ $R_{L} = 200 \Omega, V_{OD}$ | $f_C = 1 \text{ MHz}^{(4)}$, 100-kHz Tone Spacing, $R_L = 200 \Omega$, $V_{OD} = 4 V_{PP}$ envelope, $G = 10 dB$ | | | -82 | | | |
| | $f_C = 10 \text{ MHz}^{(4)}, 1$ $R_L = 200 \Omega, V_{OD}$ | 100-kHz Tone 3 = 4 V _{PP} envelo | Spacing, ope, G = 10dB | | -82 | | | |
| Input Voltage Noise | f > 10 kHz | | | | 2 | | nV/√ Hz | |
| Input Current Noise | f > 10 kHz | | | | 2 | | pA/√ Hz | |

⁽¹⁾ Test levels: **(A)** 100% tested at 25°C. Overtemperature limits by characterization and simulation. **(B)** Limits set by characterization and simulation. **(C)** Typical value only for information.

⁽²⁾ For additional information, see the Typical Characteristics section and the Apllications section.

³⁾ Data collected with applied differential input signal and measured differential output signal.

⁽⁴⁾ Data collected with applied single-ended input signal and measured differential output signal. See Figure 55 in the Applications/Test Circuits section for additional information.



SPECIFICATIONS; $V_{S+} - V_{S-} = 5 \text{ V}$: (continued)

Test conditions unless otherwise noted: V_{S+} = +2.5 V, V_{S-} = -2.5 V, G = 0 dB, CM = open, V_O = 2 V_{PP} , R_F = 499 Ω , R_L = 200 Ω Differential, T_A = 25°C Single-Ended Input, Differential Output, Input and Output Referenced to mid-supply

| PARAMETER | TEST CONDITIONS | | MIN | TYP | MAX | UNIT | TEST LEVEL ⁽¹⁾ |
|---|--|--|-------|-----------|-------|--------|------------------------------|
| DC PERFORMANCE | | | " | | | | 1. |
| Open-Loop Voltage Gain (A _{OL}) | | | | 112 | | dB | С |
| land Offers Weller | T _A = 25°C | | | ±0.25 | ±2.5 | mV | ٨ |
| Input Offset Voltage | $T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ | | | ±0.25 | ±3 | mV | А |
| Average Offset Voltage Drift | $T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ | | | 1 | | μV/°C | В |
| I 18' 0 1 | T _A = 25°C | | | 6.5 | 10 | | |
| Input Bias Current | $T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ | | | 6.4 | 11 | μΑ | A |
| Average Bias Current Drift | $T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ | | | 1.9 | | nA/°C | В |
| | T _A = 25°C | | | ±0.2 | ±2.5 | | |
| Input Offset Current | $T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ | | | ±0.2 | ±3 | μΑ | Α |
| Average Offset Current Drift | $T_A = -40^{\circ}\text{C} \text{ to } 85^{\circ}\text{C}$ | | | 1.6 | | nA/°C | В |
| INPUT | | | | | | | |
| Common-Mode Input Range High | | | | 1.75 | | ., | |
| Common-Mode Input Range Low | | | | -1.3 | | V | В |
| Common-Mode Rejection Ratio | | | | 84 | | dB | |
| Differential Input Impedance | | | | 7.5 0.31 | | kΩ pF | С |
| Common-Mode Input Impedance | | | | 2.67 0.7 | | MΩ pF | С |
| OUTPUT | l | | | | | | |
| | | T _A = 25°C | 1.95 | 2.16 | | | |
| Maximum Output Voltage High | Each output with 100 Ω to mid-supply | $T_A = -40C \text{ to} \\ 85^{\circ}C$ | 1.9 | 2.16 | | V | |
| | | T _A = 25°C | | -2.16 | -1.95 | V | Α |
| Minimum Output Voltage Low | | T _A = -40C to 85°C | | -2.16 | -1.9 | | |
| Differential Output Voltage Swing | T _A = -40C to 85°C | | 7.8 | 8.64 | | V | |
| Differential Output Current Drive | R _L = 10 Ω | | | 105 | | mA | _ |
| Output Balance Error | V _O = 100 mV, f = 1 MHz | | | -80 | | dB | С |
| OUTPUT COMMON-MODE VOLTAGE CONT | ROL | | 1 | | | | |
| Small-Signal Bandwidth | | | | 230 | | MHz | |
| Gain | | | | 1 | | V/V | |
| Output Common-Mode Offset from CM input | 1.25 V < CM < 3.5 V | | | ±0.25 | | mV | _ |
| CM Input Bias Current | 1.25 V < CM < 3.5 V | | | 0.6 | | μA | С |
| CM Input Voltage | | | -1.5 | | 1.5 | V | |
| CM Default Voltage | CM = 0.5 (V _{S+} + V _{S-}) | | | 0 | | V | |
| POWER SUPPLY | , , , , , | | 1 | | | | |
| Specified Operating Voltage | | | 3 | 5 | 5.25 | V | С |
| | T _A = 25°C | | | 14.2 | 15.3 | | |
| Maximum Quiescent Current | T _A = -40C to 85°C | | | 14.2 | 15.5 | mA | |
| | $T_A = 25^{\circ}C$ | | 13.1 | 14.2 | | | Α |
| Minimum Quiescent Current | $T_A = -40C$ to $85^{\circ}C$ | | 12.75 | 14.2 | | mA | ,, |
| Power Supply Rejection (±PSRR) | | | | 94 | | dB | |
| POWERDOWN | Referenced to V _{s-} | | | | | | |
| Enable Voltage Threshold | For additional information, se | ee the Application | | >1.5 | | V | |
| Disable Voltage Threshold | Information section of this da | | | <-1.5 | | V | С |
| | T _A = 25°C | | | 15 | 70 | | |
| Powerdown Quiescent Current | T _A = -40C to 85°C | | † | 15 | 75 | μA | A |
| | $I_A = -400 \text{ to } 85^{\circ}\text{C}$ | | 1 | | | | |



SPECIFICATIONS; $V_{S+} - V_{S-} = 3.3 \text{ V}$:

Test conditions unless otherwise noted: V_{S+} = +1.65 V, V_{S-} = -1.65 V, G = 0 dB, CM = open, V_O = 1 V_{PP} , R_F = 499 Ω , R_L = 200 Ω Differential, T_A = 25°C Single-Ended Input, Differential Output, Input and Output Referenced to mid-supply

| PARAMETER | TEST CONDITIONS MI | | | MIN | TYP | MAX | UNIT | TEST LEVEL ⁽¹⁾ |
|--|---|---|-------------------------------------|-----|------|-----|--------------------|------------------------------|
| AC PERFORMANCE | | | | | | | | |
| | $G = 0 \text{ dB}, V_O = 100 \text{ mV}_{PP}$ | | | | 600 | | MHz | |
| 0 110: 15 1:11 | $G = 6 \text{ dB}, V_0 = 100$ | $G = 6 \text{ dB}, V_O = 100 \text{ mV}_{PP}$ | | | 400 | | MHz | |
| Small-Signal Bandwidth | $G = 10 \text{ dB}, V_0 = 10$ | 00 mV _{PP} | | | 310 | | MHz | |
| | $G = 20 \text{ dB}, V_0 = 10$ | 00 mV _{PP} | | | 120 | | MHz | С |
| Gain-Bandwidth Product | G = 20 dB | | | | 1200 | | MHz | |
| Bandwidth for 0.1 dB flatness | $G = 6 \text{ dB}, V_0 = 1 \text{ V}$ | / _{PP} | | | 30 | | MHz | |
| Large-Signal Bandwidth | $G = 0 dB, V_0 = 1 V$ | / _{PP} | | | 210 | | MHz | |
| Slew Rate (Differential) | | | | | 320 | | V/µs | |
| Rise Time | | | | | 4 | | | |
| Fall Time | 2-V Step | | | | 4 | | | С |
| Settling Time to 1% | | | | | 6.6 | | ns | |
| Settling Time to 0.1% | | | | 7.1 | | | | |
| | f = 100 kHz ⁽³⁾ | $R_L = 1 k\Omega$ | $V_{OD} = 4 V_{PP}$ | | -135 | | | |
| | f = 1 MHz ⁽⁴⁾ | D 200 0 | $V_{OD} = 1 V_{PP}$ | | -107 | | | |
| | | $R_L = 200 \Omega$ | $V_{OD} = 2 V_{PP}$ | | -101 | | | |
| | | 5 410 | $V_{OD} = 1 V_{PP}$ | | -97 | | | |
| 2 nd Order Harmonic Distortion ⁽²⁾ | | $R_L = 1 k\Omega$ | $V_{OD} = 2 V_{PP}$ | | -103 | | dBc | С |
| | f = 8 MHz ⁽⁴⁾ | R _L = 200 Ω | $V_{OD} = 1 V_{PP}$ | | -108 | | | |
| | | | $V_{OD} = 2 V_{PP}$ | | -106 | | | |
| | | $R_L = 1 \text{ k}\Omega$ | V _{OD} = 1 V _{PP} | | -98 | | | |
| | | | $V_{OD} = 2 V_{PP}$ | | -99 | | | |
| | f = 100 kHz ⁽³⁾ | $R_L = 1 k\Omega$ | $V_{OD} = 4 V_{PP}$ | | -146 | | | |
| | | | V _{OD} = 1 V _{PP} | | -112 | | ! | |
| | (4) | $R_L = 200 \Omega$ | $V_{OD} = 2 V_{PP}$ | | -105 | | | |
| | f = 1 MHz ⁽⁴⁾ | | V _{OD} = 1 V _{PP} | | -94 | | | |
| 3 rd Order Harmonic Distortion ⁽²⁾ | | $R_L = 1 k\Omega$ | $V_{OD} = 2 V_{PP}$ | | -103 | | dBc | С |
| | | | V _{OD} = 1 V _{PP} | | -95 | | | |
| | 40 | $R_L = 200 \Omega$ | $V_{OD} = 2 V_{PP}$ | | -90 | | | |
| | f = 8 MHz ⁽⁴⁾ | | V _{OD} = 1 V _{PP} | | -95 | | | |
| | | $R_L = 1 k\Omega$ | $V_{OD} = 2 V_{PP}$ | | -102 | | | |
| -rd | $f_C = 1 \text{ MHz}^{(4)}, 100\text{-kHz Tone Spacing},$ $R_1 = 200 \Omega, V_{OD} = 4 \text{ Vpp envelope}, G = 10 \text{dB}$ | | | -80 | | | | |
| 3 rd Order Intermodulation Distortion | $f_C = 10$ MHz $^{(4)}$, 100-kHz Tone Spacing, $R_L = 200 \Omega$, $V_{OD} = 4$ V_{PP} envelope, $G = 10$ dB | | | | -80 | | dBc | С |
| Input Voltage Noise | f > 10 kHz | | | | 2 | | nV/√ Hz | |
| Input Current Noise | f > 10 kHz | f > 10 kHz | | | 2 | | pA/√ Hz | |

⁽¹⁾ Test levels: **(A)** 100% tested at 25°C. Overtemperature limits by characterization and simulation. **(B)** Limits set by characterization and simulation. **(C)** Typical value only for information.

⁽²⁾ For additional information, see the Typical Characteristics section and the Apllications section.

³⁾ Data collected with applied differential input signal and measured differential output signal.

⁽⁴⁾ Data collected with applied single-ended input signal and measured differential output signal. See Figure 55 in the Applications/Test Circuits section for additional information.



SPECIFICATIONS; $V_{S+} - V_{S-} = 3.3 \text{ V: (continued)}$

Test conditions unless otherwise noted: V_{S+} = +1.65 V, V_{S-} = -1.65 V, G = 0 dB, CM = open, V_{O} = 1 V_{PP} , R_{F} = 499 Ω , R_{L} = 200 Ω Differential, T_{A} = 25°C Single-Ended Input, Differential Output, Input and Output Referenced to mid-supply

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT | TEST LEVEL ⁽¹⁾ |
|---|---|-----|-------|----------|-------|------------------------------|
| DC PERFORMANCE | | | | | | |
| Open-Loop Voltage Gain (A _{OL}) | | | 104 | | dB | |
| Innut Offact Valtage | T _A = 25°C | | ±0.25 | | mV | С |
| Input Offset Voltage | $T_A = -40$ °C to 85°C | | ±0.25 | | mV | C |
| Average Offset Voltage Drift | $T_A = -40$ °C to 85°C | | 1 | | μV/°C | |
| In and Bine Outside | T _A = 25°C | | 6.5 | | | |
| Input Bias Current | $T_A = -40$ °C to 85°C | | 6.4 | | μΑ | С |
| Average Bias Current Drift | $T_A = -40$ °C to 85°C | | 1.9 | | nA/°C | |
| | T _A = 25°C | | ±0.2 | | | |
| Input Offset Current | $T_A = -40$ °C to 85°C | | ±0.2 | | μΑ | С |
| Average Offset Current Drift | $T_A = -40$ °C to 85°C | | 1.6 | | nA/°C | |
| INPUT | | | " | <u> </u> | | I. |
| Common-Mode Input Range High | | | 1.4 | | ., | |
| Common-Mode Input Range Low | | | -0.45 | | V | С |
| Common-Mode Rejection Ratio | | | 84 | | dB | |
| ОИТРИТ | | | " | <u> </u> | | I |
| Maximum Output Voltage High | T _A = 25°C | | 1.4 | | V | |
| Minimum Output Voltage Low | Each output with 100 Ω to mid-supply $T_A = 25^{\circ}C$ | | -1.4 | | | С |
| Differential Output Voltage Swing | | | 5.6 | | V | |
| Differential Output Current Drive | $R_L = 10 \Omega$ | | 78 | | mA | |
| Output Balance Error | V _O = 100 mV, f = 1 MHz | | -80 | | dB | С |
| OUTPUT COMMON-MODE VOLTA | GE CONTROL | | | | | I. |
| Small-Signal Bandwidth | | | 224 | | MHz | |
| Gain | | | 1 | | V/V | |
| Output Common-Mode Offset from CM input | 1.25 V < CM < 3.5 V | | ±0.25 | | mV | С |
| CM Input Bias Current | 1.25 V < CM < 3.5 V | | 0.6 | | μA | |
| CM Default Voltage | $CM = 0.5 (V_{S+} + V_{S-})$ | | 0 | | V | |
| POWER SUPPLY | | | " | <u> </u> | | I. |
| Specified Operating Voltage | | | 3.3 | | V | |
| Quiescent Current | T _A = 25°C | | 13 | | mA | С |
| Power Supply Rejection (±PSRR) | | | 94 | | dB | |
| POWERDOWN | Referenced to V _{s-} | | | | | |
| Enable Voltage Threshold | For additional information, see the Application Information | | >1 | | V | |
| Disable Voltage Threshold | section of this data sheet. | | <-1 | | V | С |
| Powerdown Quiescent Current | | | 10 | | μA | С |



TYPICAL CHARACTERISTICS

TYPICAL AC PERFORMANCE: $V_{S+} - V_{S-} = 5 \text{ V}$

Test conditions unless otherwise noted: V_{S+} = +2.5 V, V_{S-} = -2.5 V, CM = open, V_O = 2 V_{PP} , R_F = 499 Ω , R_L = 200 Ω Differential, G = 0 dB, Single-Ended Input, Input and Output Referenced to Midrail

| Small-Signal Frequency Resp | Figure 1 | | |
|------------------------------------|----------|--|-----------|
| Large Signal Frequency Response | | | Figure 2 |
| | HD2 | vs Frequency, V _O = 2 V _{PP} | Figure 3 |
| | HD3 | vs Frequency, V _O = 2 V _{PP} | Figure 4 |
| | HD2 | vs Frequency, V _O = 4 V _{PP} | Figure 5 |
| | HD3 | vs Frequency, V _O = 4 V _{PP} | Figure 6 |
| | HD2 | vs Output Voltage Swing, f = 1 MHz | Figure 7 |
| | HD3 | vs Output Voltage Swing, f = 1 MHz | Figure 8 |
| Harmonic Distortion ⁽¹⁾ | HD2 | vs Output Voltage Swing, f = 8 MHz | Figure 9 |
| Harmonic Distortion 7 | HD3 | vs Output Voltage Swing, f = 8 MHz | Figure 10 |
| | HD2 | vs Load Resistance, f = 1 MHz | Figure 11 |
| | HD3 | vs Load Resistance, f = 1 MHz | Figure 12 |
| | HD2 | vs Load Resistance, f = 8 MHz | Figure 13 |
| | HD3 | vs Load Resistance, f = 8 MHz | Figure 14 |
| | HD2 | vs Output common-mode voltage | Figure 15 |
| | HD3 | vs Output common-mode voltage | Figure 16 |
| 0.1 dB Flatness | | | Figure 17 |
| S-Parameters | | vs Frequency | Figure 18 |
| Slew Rate | | vs Output Voltage | Figure 19 |
| Transient Deepense | | Gain = 6 dB, $V_O = 4 V_{PP}$ | Figure 20 |
| Transient Response | | Gain = 6 dB, $V_O = 2 V_{PP}$ | Figure 21 |
| Output Voltage Swing | | vs Load Resistance | Figure 22 |
| Input Offset Voltage | | vs Input Common-Mode Voltage | Figure 23 |
| Input Bias Current | | vs Supply Voltage | Figure 24 |
| Open Loop Gain and Phase | | vs Frequency | Figure 25 |
| Input Referred Noise | | vs Frequency | Figure 26 |
| Quiescent Current | | vs Supply Voltage | Figure 27 |
| Power Supply Current | | vs Supply Voltage in Powerdown Mode | Figure 28 |
| Output Balance Error | | vs Frequency | Figure 29 |
| CM Small-Signal Frequency Response | | | Figure 30 |
| CM Input Bias Current | | vs CM Input Voltage | Figure 31 |
| Differential Output Offset Volta | age | vs CM Input Voltage | Figure 32 |
| Output Common-Mode Offset | | vs CM Input Voltage | Figure 33 |

⁽¹⁾ For additional plots, see the Applications section.



SMALL-SIGNAL FREQUENCY RESPONSE

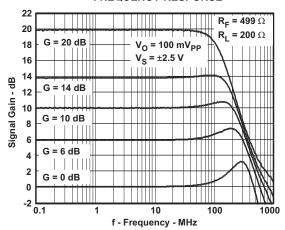
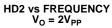


Figure 1.



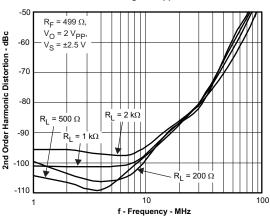
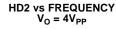


Figure 3.



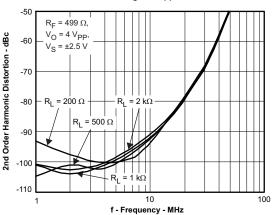


Figure 5.

LARGE-SIGNAL FREQUENCY RESPONSE

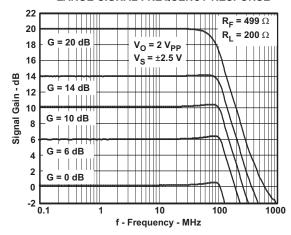


Figure 2.

$\begin{array}{c} \text{HD3 vs FREQUENCY} \\ \text{V}_{\text{O}} = 2\text{V}_{\text{PP}} \end{array}$

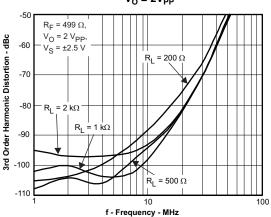


Figure 4.

HD3 vs FREQUENCY $V_O = 4V_{PP}$

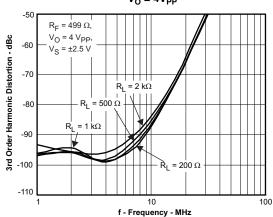


Figure 6.



HD2 vs OUTPUT VOLTAGE SWING FREQUENCY = 1MHz

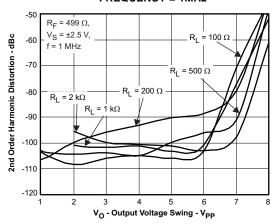


Figure 7.

HD2 vs OUTPUT VOLTAGE SWING FREQUENCY = 8MHz

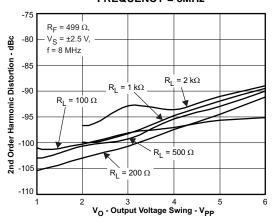


Figure 9.

HD2 vs LOAD RESISTANCE FREQUENCY = 1MHz

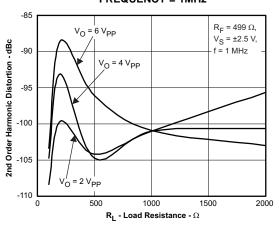


Figure 11.

HD3 vs OUTPUT VOLTAGE SWING FREQUENCY = 1MHz

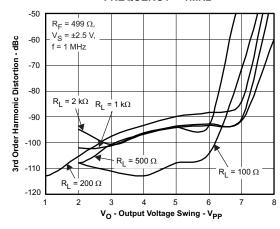


Figure 8.

HD3 vs OUTPUT VOLTAGE SWING FREQUENCY = 8MHz

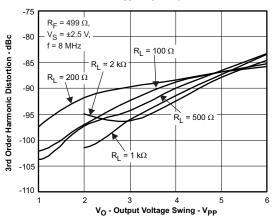


Figure 10.

HD3 vs LOAD RESISTANCE FREQUENCY = 1MHz

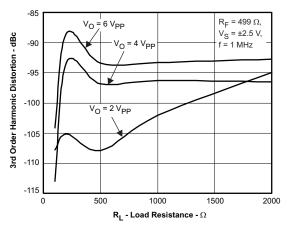


Figure 12.



HD2 vs LOAD RESISTANCE FREQUENCY = 8MHz

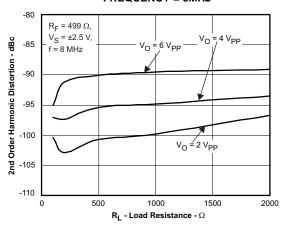


Figure 13.

HD2 vs OUTPUT COMMON-MODE VOLTAGE

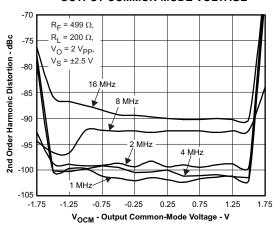


Figure 15.



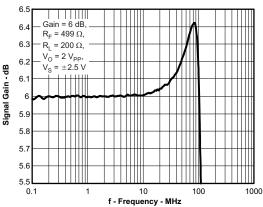


Figure 17.

HD3 vs LOAD RESISTANCE FREQUENCY = 8MHz

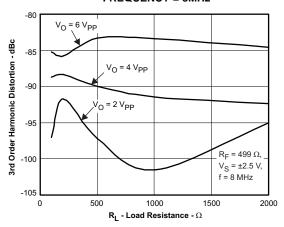


Figure 14.

HD3 vs OUTPUT COMMON-MODE VOLTAGE

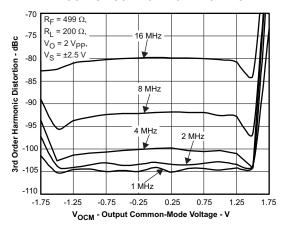


Figure 16.

S-PARAMETERS vs FREQUENCY

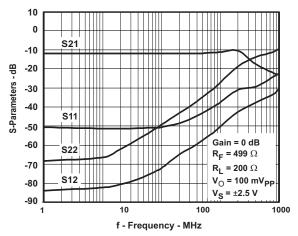
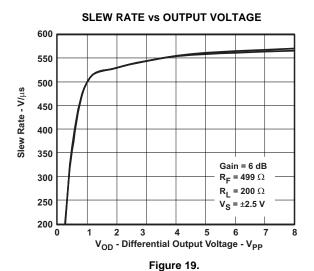
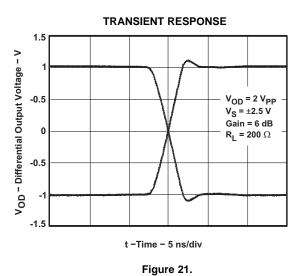
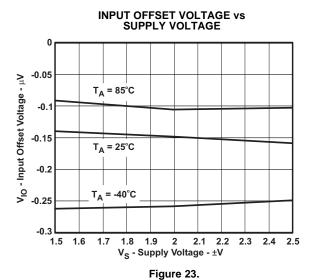


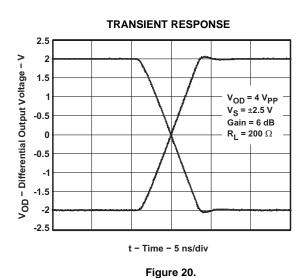
Figure 18.

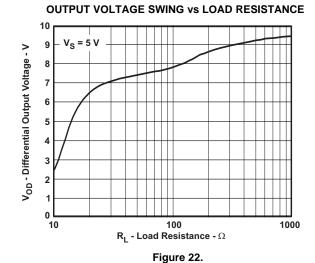












INPUT BIAS CURRENT VS SUPPLY VOLTAGE

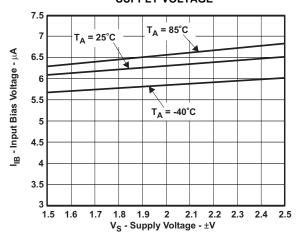


Figure 24.



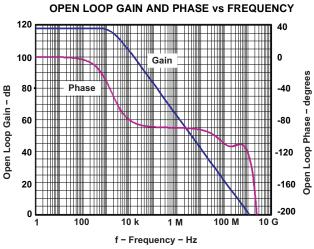
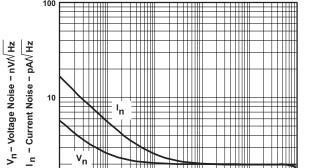


Figure 25.





INPUT REFERRED NOISE vs FREQUENCY

10 100 1 k 10 k 100 k 1 M f - Frequency - Hz

Figure 26.

QUIESCENT CURRENT vs SUPPLY VOLTAGE

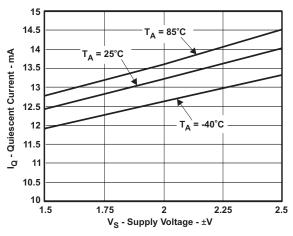


Figure 27.

POWER SUPPLY CURRENT vs SUPPLY VOLTAGE IN POWER-DOWN MODE

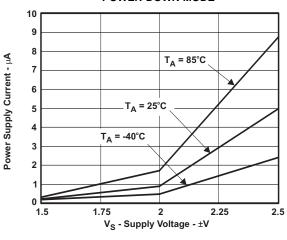


Figure 28.

OUTPUT BALANCE ERROR vs FREQUENCY

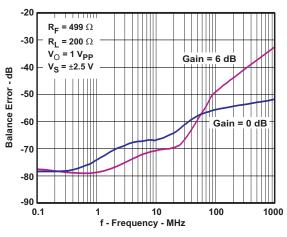


Figure 29.

CM SMALL SIGNAL FREQUENCY RESPONSE

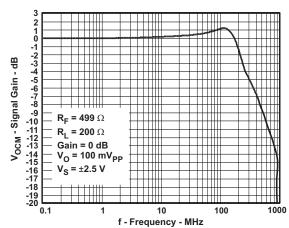


Figure 30.

-150 -2.5 -2 -1.5



200

CM INPUT BIAS CURRENT vs CM INPUT VOLTAGE



-1 -0.5 0

V_{ICR} - Common-Mode Input Voltage - V Figure 31.

0.5

1.5

DIFFERENTIAL OUTPUT OFFSET VOLTAGE vs CM INPUT VOLTAGE

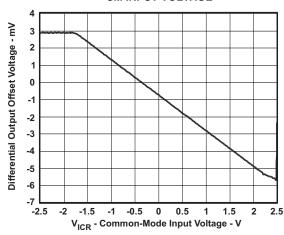


Figure 32.

OUTPUT COMMON-MODE OFFSET vs CM INPUT VOLTAGE

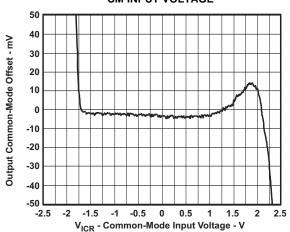


Figure 33.



TYPICAL AC PERFORMANCE: $V_{S+} - V_{S-} = 3.3 \text{ V}$

Test conditions unless otherwise noted: $V_{S+}=1.65~V,~V_{S-}=-1.65~V,~CM=open,~V_{OD}=1~V_{PP},~R_F=499~\Omega,~R_L=200~\Omega$ Differential, G = 0 dB, Single-Ended Input, Input and Output Referenced to Midrail

| Small-Signal Frequency Resp | Figure 34 | | |
|-----------------------------|-----------|---|-----------|
| Large Signal Frequency Resp | onse | | Figure 35 |
| | HD2 | vs Frequency | Figure 36 |
| | HD3 | vs Frequency | Figure 37 |
| | HD2 | vs Output Voltage Swing, f = 1 MHz | Figure 38 |
| | HD3 | vs Output Voltage Swing, f = 1 MHz | Figure 39 |
| | HD2 | vs Output Voltage Swing, f = 8 MHz | Figure 40 |
| Harmonic Distortion (1) | HD3 | vs Output Voltage Swing, f = 8 MHz | Figure 41 |
| Harmonic Distortion | HD2 | vs Load Resistance, f = 1 MHz | Figure 42 |
| | HD3 | vs Load Resistance, f = 1 MHz | Figure 43 |
| | HD2 | vs Load Resistance, f = 8 MHz | Figure 44 |
| | HD3 | vs Load Resistance, f = 8 MHz | Figure 45 |
| | HD2 | vs Output common-mode voltage, $V_0 = 2 V_{pp}$ | Figure 46 |
| | HD3 | vs Output common-mode voltage, $V_0 = 2 V_{pp}$ | Figure 47 |
| 0.1 dB Flatness | · | | Figure 48 |
| S-Parameters | | vs Frequency | Figure 49 |
| Slew Rate | | vs Output Voltage | Figure 50 |
| Transient Response | | Gain = 6 dB, $V_O = 4 V_{pp}$ | Figure 51 |
| | | Gain = 6 dB, $V_O = 2 V_{pp}$ | Figure 52 |
| Output Balance Error | | vs Frequency | Figure 53 |
| CM Input Impedance | | vs Frequency | Figure 54 |

(1) For additional plots, see the Applications section.

SMALL-SIGNAL FREQUENCY RESPONSE

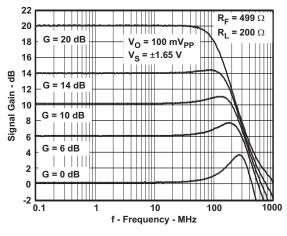


Figure 34.

LARGE-SIGNAL FREQUENCY RESPONSE

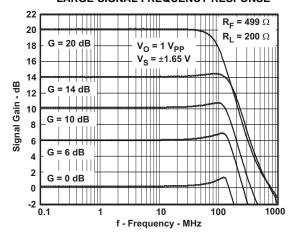


Figure 35.



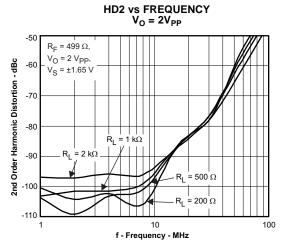


Figure 36.

HD2 vs OUTPUT VOLTAGE SWING FREQUENCY = 1MHz

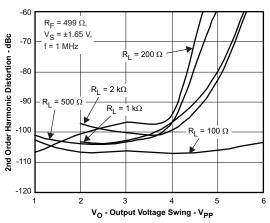


Figure 38.

HD2 vs OUTPUT VOLTAGE SWING FREQUENCY = 8MHz

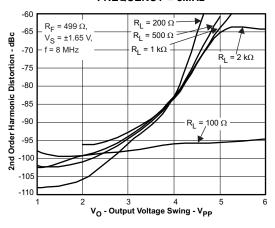


Figure 40.

HD3 vs FREQUENCY $V_O = 2V_{PP}$

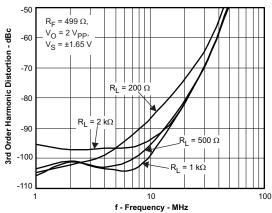


Figure 37.

HD3 vs OUTPUT VOLTAGE SWING FREQUENCY = 1MHz

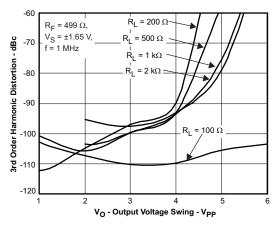


Figure 39.

HD3 vs OUTPUT VOLTAGE SWING FREQUENCY = 8MHz

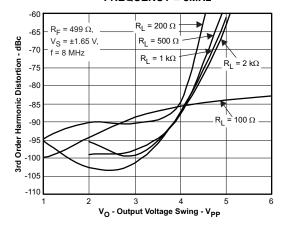


Figure 41.



HD2 vs LOAD RESISTANCE FREQUENCY = 1MHZ

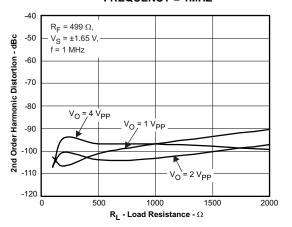


Figure 42.

HD2 vs LOAD RESISTANCE FREQUENCY = 8MHZ

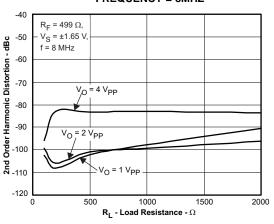


Figure 44.

HD2 vs OUTPUT COMMON-MODE VOLTAGE

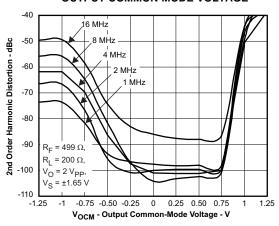


Figure 46.

HD3 vs LOAD RESISTANCE FREQUENCY = 1MHZ

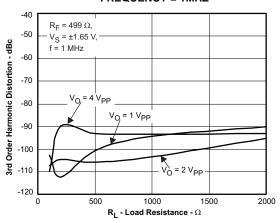


Figure 43.

HD3 vs LOAD RESISTANCE FREQUENCY = 8MHZ

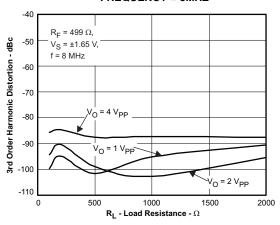


Figure 45.

HD3 vs OUTPUT COMMON-MODE VOLTAGE

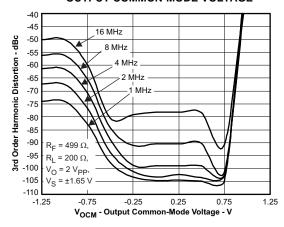
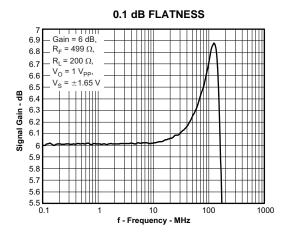
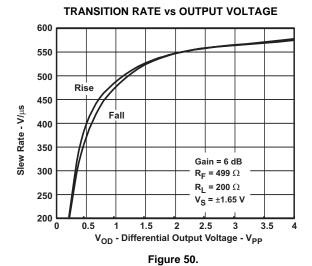


Figure 47.









Notation of the property of t

TRANSIENT RESPONSE

t -Time - 5 ns/div Figure 52.

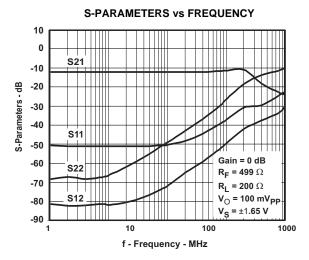


Figure 49.

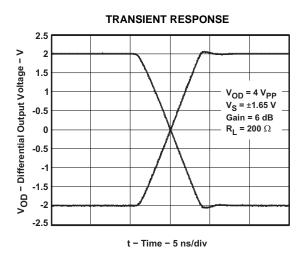


Figure 51.

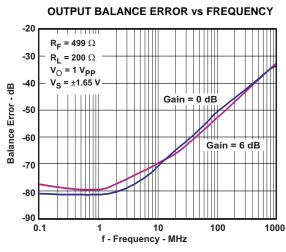
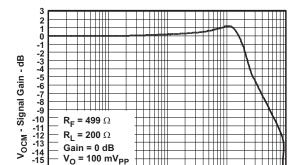


Figure 53.

1.5





V_S = ±1.65 V

CM SMALL SIGNAL FREQUENCY RESPONSE

f - Frequency - MHz Figure 54.

10

TEST CIRCUITS

The THS4520 is tested with the following test circuits built on the EVM. For simplicity, power supply decoupling is not shown – see layout in the applications section for recommendations.

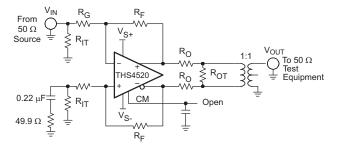


Figure 55. General Test Circuit for Device Testing and Characterization

Depending on the test conditions, component values are changed per the following tables, or as otherwise noted. The signal generators used are ac coupled 50- Ω sources and a 0.22- μF capacitor and a 49.9- Ω resistor to ground are inserted across R_{IT} on the alternate input to balance the circuit. A split power supply is used to ease the interface to common test equipment, but the amplifier can be operated single-supply as described in the applications section with no impact on performance.

Table 1. Gain Component Values

| GAIN | R _F | R _G | R _{IT} |
|-------|----------------|----------------|-----------------|
| 0 dB | 499 Ω | 487 Ω | 53.6 Ω |
| 6 dB | 499 Ω | 243 Ω | 57.6 Ω |
| 10 dB | 499 Ω | 147 Ω | 63.4 Ω |
| 14 dB | 499 Ω | 88.7 Ω | 71.5 Ω |

 GAIN
 R_F R_G R_{IT}

 20 dB
 499 Ω
 34.8 Ω
 115 Ω

1000

Note: The gain setting includes $50-\Omega$ source impedance. Components are chosen to achieve gain and $50-\Omega$ input termination.

Table 2. Load Component Values

| R_{L} | Ro | R _{OT} | Atten. |
|---------|--------|-----------------|---------|
| 100 Ω | 25 Ω | open | 6 dB |
| 200 Ω | 86.6 Ω | 69.8 Ω | 16.8 dB |
| 499 Ω | 237 Ω | 56.2 Ω | 25.5 dB |
| 1 kΩ | 487 Ω | 52.3 Ω | 31.8 dB |
| 2 k | 976 | 51.1 | -37.86 |

Note: The total load includes $50-\Omega$ termination by the test equipment. Components are chosen to achieve load and $50-\Omega$ line termination through a 1:1 transformer.

Due to the voltage divider on the output formed by the load component values, the amplifier's output is attenuated in test. The column *Atten* in Table 2 shows the attenuation expected from the resistor divider. When using a transformer at the output the signal will have slightly more loss, and the numbers will be approximate.

Frequency Response

The general circit shown in Figure 55 is modified as shown in Figure 56, and is used to measure the frequency response of the device.

A network analyzer is used as the signal source and as the measurement device. The output impedance



of the network analyzer is 50 Ω . R_{IT} and R_G are chosen to impedance match to 50 Ω , and to maintain the proper gain. To balance the amplifier, a 0.22- μ F capacitor and 49.9- Ω resistor to ground are inserted across R_{IT} on the alternate input.

The output is probed using a high-impedance differential probe across the $100-\Omega$ resistor. The gain is referred to the amplifier output by adding back the 6-dB loss due to the voltage divider on the output.

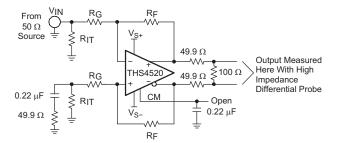


Figure 56. Frequency Response Test Circuit

S-Parameter, Slew Rate, Transient Response, Settling Time, Output Voltage

The circuit shown in Figure 57 is used to measure s-parameters, slew rate, transient response, settling time, and output voltage swing.

Because S21 is measured single-ended at the load with $50-\Omega$ double termination, add 12 dB to see the amplifier's output as a differential signal.

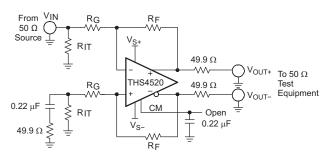


Figure 57. S-Parameter, SR, Transient Response, Settling Time, V_{OUT} Swing

CM Input

The circuit shown in Figure 58 is used to measure the frequency response of the CM input. Frequency response is measured single-ended at V_{OUT+} or V_{OUT-} with the input injected at V_{IN} , $R_{CM}=0$ Ω and $R_{CMT}=49.9$ Ω .

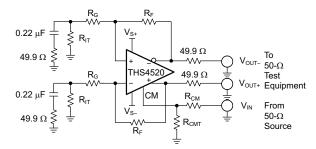


Figure 58. CM Input Test Circuit



APPLICATION INFORMATION

APPLICATIONS

The following circuits show application information for the THS4520. For simplicity, power supply decoupling capacitors are not shown in these diagrams. For more detail on the use and operation of fully differential op amps see application report *Fully-Differential Amplifiers* (SLOA054) .

Differential Input to Differential Output Amplifier

The THS4520 is a fully differential op amp, and can be used to amplify differential input signals to differential output signals. A basic block diagram of the circuit is shown in Figure 59 (CM input not shown). The gain of the circuit is set by R_{F} divided by $R_{\text{G}}.$

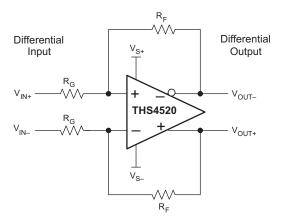


Figure 59. Differential Input to Differential Output Amplifier

Depending on the source and load, input and output termination can be accomplished by adding R_{IT} and $R_{\text{O}}.$

Single-Ended Input to Differential Output Amplifier

The THS4520 can be used to amplify and convert single-ended input signals to differential output signals. A basic block diagram of the circuit is shown in Figure 60 (CM input not shown). The gain of the circuit is again set by $R_{\rm F}$ divided by $R_{\rm G}$.

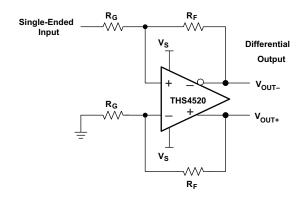


Figure 60. Single-Ended Input to Differential Output Amplifier

Input Common-Mode Voltage Range

The input common-model voltage of a fully differential op amp is the voltage at the '+' and '-' input pins of the op amp.

It is important to not violate the input common-mode voltage range (V_{ICR}) of the op amp. Assuming the op amp is in linear operation, the differential voltage across the input pins is only a few millivolts at most. So finding the voltage at one input pin determines the input common-mode voltage of the op amp.

Treating the negative input as a summing node, the voltage is given by Equation 1:

$$V_{IC} = \left(V_{OUT+} \times \frac{R_G}{R_G + R_F}\right) + \left(V_{IN-} \times \frac{R_F}{R_G + R_F}\right) \tag{1}$$

To determine the V_{ICR} of the op amp, the voltage at the negative input is evaluated at the extremes of V_{OUT+} .

As the gain of the op amp increases, the input common-mode voltage becomes closer and closer to the input common-mode voltage of the source.

Setting the Output Common-Mode Voltage

The output common-mode voltage is set by the voltage at the CM pin. The internal common-mode control circuit maintains the output common-mode voltage within 0.25-mV offset (typical) from the set voltage, when set within ±0.5 V of mid-supply. If left unconnected, the common-mode set point is set to mid-supply by internal circuitry, which may be over-driven from an external source. Figure 61 is representative of the CM input. The internal CM circuit has about 230 MHz of bandwidth, which is



required for best performance, but it is intended to be a DC bias input pin. Bypass capacitors are recommended on this pin to reduce noise at the output. The external current required to overdrive the internal resistor divider is given by Equation 2:

$$I_{EXT} = \frac{2V_{CM} - (V_{S+} - V_{S-})}{50 \text{ k}\Omega}$$
 (2)

where V_{CM} is the voltage applied to the CM pin.

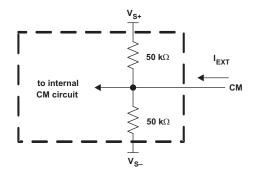


Figure 61. CM Input Circuit

Powerdown Operation: Device Enable/Disable Thresholds

The enable/disable thresholds of the THS4520 are dependent upon the power supplies, and the thresholds are always referenced to the lower power supply rail. The device is enabled or disabled for the following conditions:

- Device enabled: $V_{PD} > V_{S-} + 0.8 \text{ x } (V_{S+} V_{S-})$
- Device disabled: $V_{PD} < V_{S-} + 0.2 \text{ x } (V_{S+} V_{S-})$

If the \overline{PD} pin is left open, the device will default to the enabled state.

Table 3 shows the thresholds for some common power supply configurations:

Table 3. Power Supply Configurations

| Power Supply (V _{S+} , V _{S-}) | Enable Threshold (V) | Disable Threshold (V) | Comment |
|---|----------------------------|-----------------------------|----------------------------|
| ±2.5 V | 1.5 | -1.5 | Shown in data table |
| ±1.65 V | 1 | -1 | Shown in data table |
| (4 V , -1 V) | 3 | 0 | Split, unbalanced supplies |
| (5 V, gnd) | 4 | 1 | Single-sided supply |
| (3.3 V, gnd) | 2.64 | 0.66 | Single-sided supply |
| (3 V, gnd) | 2.4 | 0.6 | Single-sided supply |

Single-Supply Operation (3 V to 5 V)

To facilitate testing with common lab equipment, the THS4520 EVM allows split-supply operation, and the characterization data presented in this data sheet was taken with split-supply power inputs. The device can easily be used with a single-supply power input without degrading the performance. Figure 62, Figure 63, and Figure 64 show DC and AC-coupled single-supply circuits with single-ended inputs. These configurations all allow the input and output common-mode voltage to be set to mid-supply allowing for optimum performance. The information presented here can also be applied to differential input sources.

In Figure 62, the source is referenced to the same voltage as the CM pin (V_{CM}). V_{CM} is set by the internal circuit to mid-supply. R_T along with the input impedance of the amplifier circuit provides input termination, which is also referenced to V_{CM} .

Note R_S and R_T are added to the alternate input from the signal input to balance the amplifier. Alternately, one resistor can be used equal to the combined value $R_G + R_S || R_T$ on this input. This is also true of the circuits shown in Figure 63 and Figure 64.

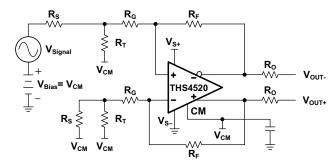


Figure 62. THS4520 DC Coupled Single-Supply with Input Biased to V_{CM}

In Figure 63 the source is referenced to ground and so is the input termination resistor. R_{PU} is added to the circuit to avoid violating the V_{ICR} of the op amp. The proper value of resistor to add can be calculated from Equation 3:

$$R_{PU} = \frac{(V_{IC} - V_{S+})}{V_{CM} \left(\frac{1}{R_F}\right) - V_{IC} \left(\frac{1}{R_{IN}} + \frac{1}{R_F}\right)}$$
(3)

 V_{IC} is the desired input common-mode voltage, $V_{CM} = CM, \ and \ R_{IN} = R_G + R_S || R_T.$ To set to mid-supply, make the value of $R_{PU} = R_G + R_S || R_T.$



Table 4 is a modification of Table 1 to add the proper values with R_{PU} assuming a $50-\Omega$ source impedance and setting the input and output common-mode voltage to mid-supply.

There are two drawbacks to this configuration. One is it requires additional current from the power supply. Using the values shown for a gain of 0 dB requires 10 mA more current with 5-V supply, and 6.5 mA more current with 3.3-V supply.

The other drawback is this configuration also increases the noise gain of the circuit. In the 10-dB gain case, noise gain increases by a factor of 1.7.

Table 4. RPU Values for Various Gains

| Gain | R _F | R_{G} | R _{IT} | R _{PU} |
|-------|----------------|---------|-----------------|-----------------|
| 0 dB | 499 Ω | 487 Ω | 54.9 Ω | 511 Ω |
| 6 dB | 499 Ω | 243 Ω | 59 Ω | 270 Ω |
| 10 dB | 499 Ω | 150 Ω | 68.1 Ω | 178 Ω |
| 14 dB | 499 Ω | 93.1 Ω | 82.5 Ω | 124 Ω |
| 20 dB | 499 Ω | 40.2 Ω | 221 Ω | 80.6 Ω |

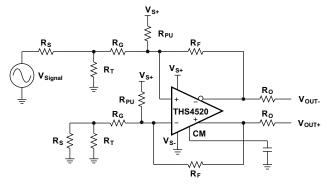


Figure 63. THS4520 DC Coupled Single-Supply with R_{PU} Used to Set V_{IC}

Figure 64 shows AC coupling to the source. Using capacitors in series with the termination resistors allows the amplifier to self-bias both input and output to mid-supply.

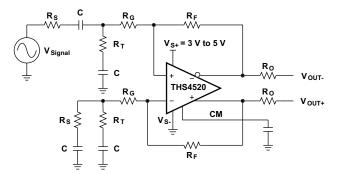


Figure 64. THS4520 AC Coupled Single-Supply

FULLY DIFFERENTIAL AMPLIFIER WITH REDUCED PEAKING

Figure 65 shows a fully differential amplifier that reduces peaking at low gains. The resistor $R_{\rm C}$ compensates the THS4520 to have higher noise gain (NG), which reduces the AC response peaking (typically 3.8dB at G = +1 without $R_{\rm C}$) without changing the DC forward gain. The input signal, $V_{\rm IN}$, is assumed to be from a low impedance source, such as an op amp.

When the two feedback paths are symmetrical, the noise gain is given by the expression:

$$NG = 1 + \frac{R_F}{R_G} + \frac{2R_F}{R_C}$$

$$V_{IN} \xrightarrow{R_G} V_{S+} \xrightarrow{V_{S+}} V_{OUT}$$

$$R_G \xrightarrow{R_G} V_{S+} \xrightarrow{V_{S-}} V_{OUT}$$

Figure 65. THS4520 with Noise Gain Compensation

A unity-gain buffer can be designed by selecting $R_{\text{F}}=499~\Omega,~R_{\text{G}}=499~\Omega$ and $R_{\text{C}}=$ open. The resulting forward gain response is similar to the characteristics plots with G = 0dB (see Figure 1), and the noise gain equal to 2. If R_{C} is then made equal to 200 Ω the noise gain increases to 7, which typically gives a frequency response with less peaking and with less bandwidth, and the forward gain remains equal to unity.

The plot in Figure 66 shows the measured small-signal AC response of a THS4520 EVM in the default unity-gain configuration (see Figure 72). When the termination resistors present on the EVM (R1, R2, and R12 in Figure 72) and the source resistance of the signal generator (R_S = 50 Ω) are taken into account, the calculated noise gain of the default EVM is NG = 1.97. Also included in the plot are two curves which represent the measured response of the same board with two values of R_C, one with R_C = 200 Ω (NG = 6.96) and one with R_C =487 Ω (NG = 4.02). The low-frequency roll-off of the AC response is due to the transformer (T1 in Figure 72). The curves illustrate the reduced peaking



and the reduced bandwidth due to increased noise gain when the circuit is configured for low forward gain. Note that using noise gain compensation increases the circuit output noise and decreases the circuit bandwidth. Compared to the default configuration (no $R_{\text{C}})$ using R_{C} = 200 Ω and R_{C} = 487 Ω increases the circuit output noise by approximately 10.9dB and 6dB respectively.

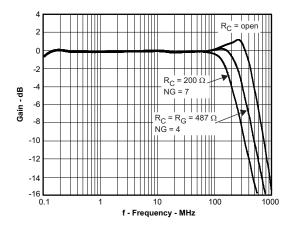


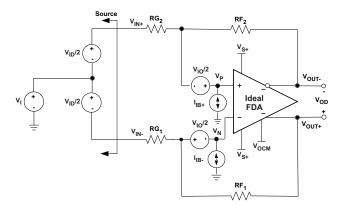
Figure 66. THS4520 EVM Small Signal Response With and Without Noise Gain Compensation

DC ERRORS IN A FULLY DIFFERENTIAL AMPLIFIER

Summarv

A DC error model of a fully differential voltage feedback amplifier shown in the following circuit diagram. The output error has four contributing factors in this model:

- 1. Input offset voltage (V_{IO}).
- 2. Input offset current (I_{IO}).
- 3. Input bias currents (I_{IB+}, I_{IB-}) interacting with mismatched feedback networks.
- 4. Mismatch between input and output common-mode voltages interacting with the mismatched feedback networks.



When there is no mismatch between the feedback networks ($RF_1 = RF_2$ and $RG_1 = RG_2$) the output error due to the input offset voltage is given by:

$$\Delta V_{OD}(V_{IO}) = V_{IO} \frac{RG + RF}{RG} = V_{IO}/\beta$$
 (5)

where β is often called the *feedback factor*.

$$\beta = \frac{RG}{RG + RF} \tag{6}$$

For additional information, see the applications note *Fully Differential Amplifiers* (SLOA054).

The output error due to the input offset current is given by:

$$\Delta V_{OD}(I_{IO}) = I_{IO}RF \tag{7}$$

If there is mismatch ($RF_1 \neq RF_2$ or $RG_1 \neq RG_2$), then the output error due to the input bias currents is:

$$\Delta V_{OD}(I_{IB}, I_{IO}) = 2 \frac{I_{IB}(R_{EQ1} - R_{EQ2}) + I_{IO}(R_{EQ1} + R_{EQ2})}{(\beta_1 + \beta_2)}$$
(8)

Where $I_{lB}=(I_{lB+}+I_{lB-})/2,\ R_{EQ1,2}=RF_{1,2}\ ||\ RG_{1,2}$ and $\beta_{1,2}=RG_{1,2}/(RG_{1,2}+RF_{1,2}).$

There is an additional contribution to the output error if the input and output common-mode voltages are mismatched:

$$\Delta V_{OD}(V_{OCM}, V_{ICM}) = 2 \times \left(V_{OCM} - V_{ICM}\right) \frac{(\beta_1 - \beta_2)}{(\beta_1 + \beta_2)}$$
(9)

Note that this source of output error will be negligible if the two feedback paths are well matched. The analysis that leads to the results shown above is beyond the scope of this section. An applications note that shows the detailed analysis will be available in the near future.

DEPENDENCE OF HARMONIC DISTORTION ON DEVICE OUTPUT SWING AND SIGNAL FREQUENCY

Typical plots of HD2 or HD3 usually show the dependence of these parameters upon a single variable, like frequency, output swing, load, or circuit gain. Operating conditions of interest are usually dependent on several variables that are often spread across several different plots. This forces the designer to interpolate across several plots in an attempt to capture the parameters and operating conditions for his/her application.

Unlike typical plots where HD2 or HD3 is plotted against a single variable, the plots below show constant contours of THS4520 HD2 and HD3 plotted against the joint parameters of device output swing and signal frequency. These two parameters are of



particular interest because their joint interaction reflects the usable slewing and bandwidth limits of a device. Output swing and frequency limits are often prime consideration when picking a device and quantifying their joint impact on HD allows a more precise judgment on the ability of a device to meet the *need for speed*. The curves that separate each colored region represent the value of HD2,3 indicated on the plot. Following a curve over the ranges of output swing and frequency show the conditions over which that value of HD2,3 occurs.

Note that the horizontal axis represents the base-10 logarithm of frequency in units of MHz. So on the horizontal axis the value of '2' represents 100 MHz, '1' represents 10 MHz and '0' represents 1 MHz, respectively. This strategy was chosen to provide spacing between curves that allowed the viewer to easily resolve the individual curves. Plotting frequency on a linear scale caused the curves to be crowded and difficult to distinguish. Unfortunately a semilog axis format was not possible because of the plotting function. The measured data in the plots

represent measurements of a THS4520 evaluation board in the default unity-gain configuration with $R_L = 200\Omega$. For more information on the circuit configuration, see the information on the THS4520 evaluation board later in this section.

The first two plots (Figure 67 and Figure 68) are for HD2 and HD3 respectively, with a power supply of ±2.5 V. The line labeled Large Signal BW in each of the two plots represents the measured large signal bandwidth over the range of output signal swing in the plot ($V_{out} = 1 \ V_{pp}$ to $8 \ V_{pp}$). The BW lines fall in the shaded region that represents very poor distortion performance: HD2 > -45dBc or HD3 > -40dBc. The intent in plotting the bandwidth was to provide a realistic comparison between the reported large signal bandwidth and useful distortion performance. The areas between the plots are shaded to help illustrate the 10dB changes in HD2 or HD3 between the adjacent curves. The third and fourth plots (Figure 69andFigure 70) are the constant contours of HD2 and HD3 respectively for a power supply of ±1.65 V.

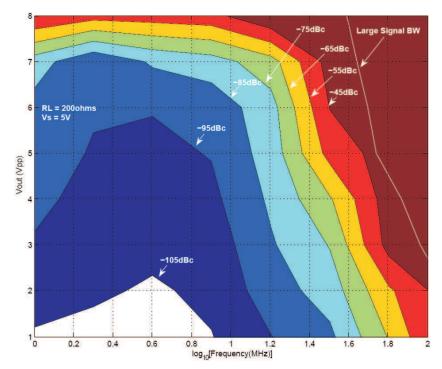


Figure 67. Constant HD2 Contours vs Output Swing and \log_{10} (Frequency - MHz) V_s = 2.5 V, Gain = 1, R_L = 200 Ω



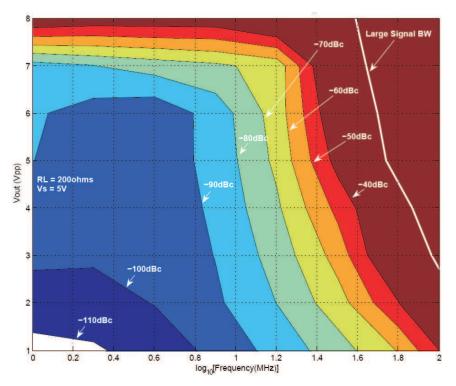


Figure 68. Constant HD3 Contours vs Output Swing and \log_{10} (Frequency - MHz) $\rm V_s=2.5~V,~Gain=1,~R_L=200~\Omega$

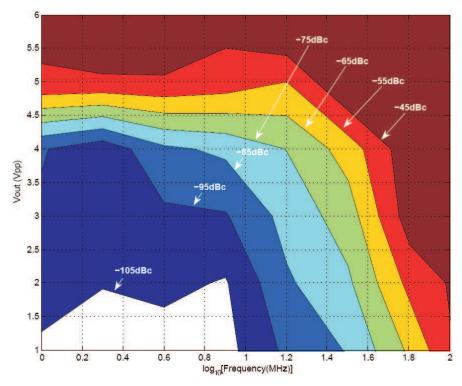


Figure 69. Constant HD2 Contours vs Output Swing and \log_{10} (Frequency - MHz) $\rm V_s$ = 1.65 V, Gain = 1, $\rm R_L$ = 200 $\rm \Omega$



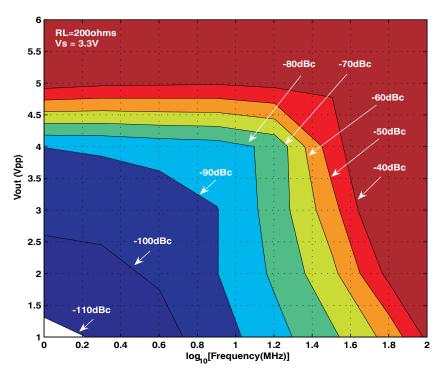


Figure 70. Constant HD2 Contours vs Output Swing and \log_{10} (Frequency - MHz) $V_s = 1.65$ V, Gain = 1, $R_1 = 200$ Ω

Layout Recommendations

It is recommended to follow the layout of the external components near the amplifier, ground plane construction, and power routing of the EVM as closely as possible. General guidelines are:

- Signal routing should be direct and as short as possible into and out of the op amp circuit.
- 2. The feedback path should be short and direct avoiding vias.
- Ground or power planes should be removed from directly under the amplifier's input and output pins.
- 4. An output resistor is recommended on each output, as near to the output pin as possible.
- 5. Two 10-μF and two 0.1-μF power-supply decoupling capacitors should be placed as near to the power-supply pins as possible.
- Two 0.1-μF capacitors should be placed between the CM input pins and ground. This limits noise coupled into the pins. One each should be placed to ground near pin 4 and pin 9.
- It is recommended to split the ground pane on layer 2 (L2) as shown below and to use a solid ground on layer 3 (L3). A single-point connection should be used between each split section on L2 and L3.

- A single-point connection to ground on L2 is recommended for the input termination resistors R1 and R2. This should be applied to the input gain resistors if termination is not used.
- 9. The THS4520 recommended PCB footprint is shown in Figure 71.

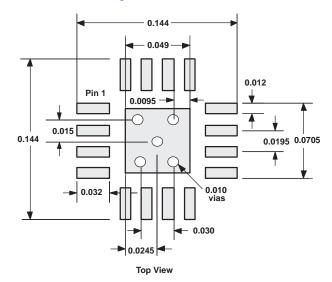


Figure 71. QFN Etch and Via Pattern



THS4520 EVM

Figure 72 is the THS4520 EVAL1 EVM schematic, layers 1 through 4 of the PCB are shown Figure 73, and Table 5 is the bill of material for the EVM as supplied from TI.

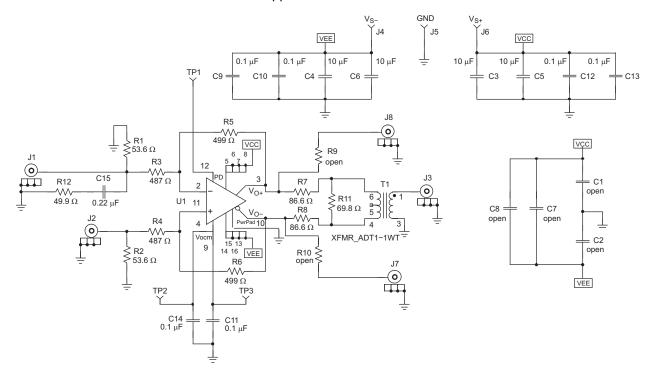


Figure 72. THS4520 EVAL1 EVM Schematic

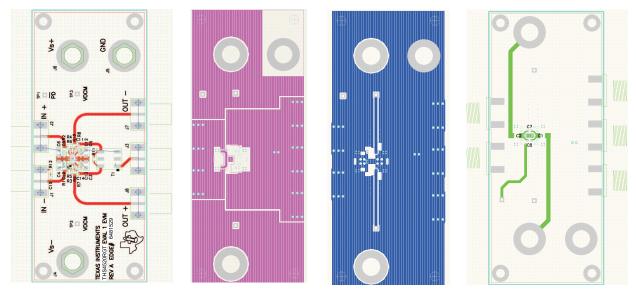


Figure 73. THS4520 EVAL1 EVM Layer 1 through 4



Table 5. THS4520 EVAL1 EVM Bill of Materials

| ITEM | DESCRIPTION | SMD SIZE | REFERENCE DESIGNATOR | PCB QTY | MANUFACTURER'S PART NUMBER |
|------|--|-------------|-----------------------------|------------|-------------------------------|
| 1 | CAP, 10.0 μF, Ceramic, X5R, 6.3V | 0805 | C3, C4, C5, C6 | 4 | (AVX) 08056D106KAT2A |
| 2 | CAP, 0.1 μF, Ceramic, X5R, 10V | 0402 | C9, C10, C11, C12, C13, C14 | 6 | (AVX) 0402ZD104KAT2A |
| 3 | CAP, 0.22 ΩF, Ceramic, X5R, 6.3V | 0402 | C15 | 1 | (AVX) 04026D224KAT2A |
| 4 | OPEN | 0402 | C1, C2, C7, C8 | 4 | |
| 5 | OPEN | 0402 | R9, R10 | 2 | |
| 6 | Resistor, 49.9 Ω, 1/16W, 1% | 0402 | R12 | 1 | (KOA) RK73H1ETTP49R9F |
| 7 | Resistor, 53.6 Ω, 1/16W, 1% | 0402 | R1, R2 | 2 | (KOA) RK73H1ETTP53R6F |
| 8 | Resistor, 69.8 Ω, 1/16W, 1% | 0402 | R11 | 1 | (KOA) RK73H1ETTP69R8F |
| 9 | Resistor, 86.6 Ω, 1/16W, 1% | 0402 | R7, R8 | 2 | (KOA) RK73H1ETTP86R6F |
| 10 | Resistor, 487 Ω, 1/16W, 1% | 0402 | R3, R4 | 2 | (KOA) RK73H1ETTP4870F |
| 11 | Resistor, 499 Ω, 1/16W, 1% | 0402 | R5, R6 | 2 | (KOA) RK73H1ETTP4990F |
| 12 | Transformer, RF | | T1 | 1 | (MINI-CIRCUITS) ADT1-1WT |
| 13 | Jack, banana receptance, 0.25" diameter hole | | J4, J5, J6 | 3 | (HH SMITH) 101 |
| 14 | OPEN | | J1, J7, J8 | 3 | |
| 15 | Connector, edge, SMA PCB Jack | | J2, J3 | 2 | (JOHNSON) 142-0701-801 |
| 16 | Test point, Red | | TP1, TP2, TP3 | 3 | (KEYSTONE) 5000 |
| 17 | IC, THS4520 | | U1 | 1 | (TI) THS4520RGT |
| 18 | Standoff, 4-40 HEX, 0.625" length | | | 4 | (KEYSTONE) 1808 |
| 19 | SCREW, PHILLIPS, 4-40, 0.250" | | | 4 | SHR-0440-016-SN |
| 20 | Printed circuit board | | | 1 | (TI) EDGE# 6481529 |

EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range of 3 V to 5 V and the output voltage range of 3 V to 5 V.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 85 = C. The EVM is designed to operate properly with certain components above 85 = C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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11-Nov-2025

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PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ Ball material | MSL rating/ Peak reflow | Op temp (°C) | Part marking (6) |
|-----------------------|------------|---------------|-----------------|-----------------------|------|-------------------------------|----------------------------|--------------|------------------|
| THS4520RGTR | Active | Production | VQFN (RGT) 16 | 3000 LARGE T&R | Yes | NIPDAU | (5) Level-2-260C-1 YEAR | -40 to 85 | 4520 |
| THS4520RGTR.B | Active | Production | VQFN (RGT) 16 | 3000 LARGE T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | 4520 |
| THS4520RGTT | Active | Production | VQFN (RGT) 16 | 250 SMALL T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | 4520 |
| THS4520RGTT.B | Active | Production | VQFN (RGT) 16 | 250 SMALL T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | 4520 |
| THS4520RGTTG4 | Active | Production | VQFN (RGT) 16 | 250 SMALL T&R | Yes | NIPDAU | Level-2-260C-1 YEAR | -40 to 85 | 4520 |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

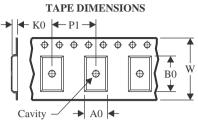
⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

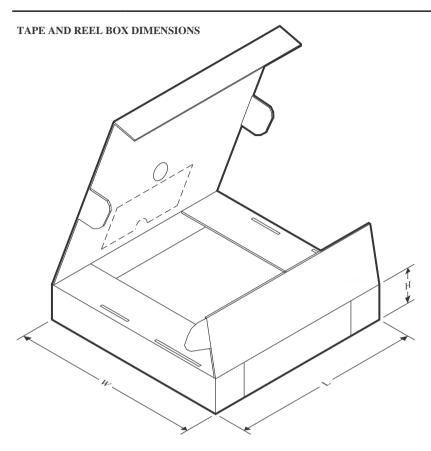
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

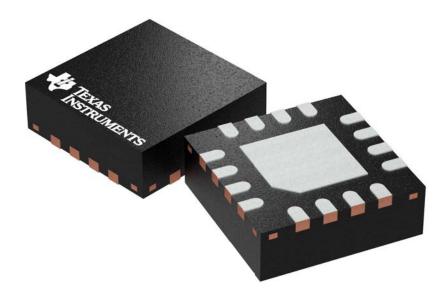
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| THS4520RGTR | VQFN | RGT | 16 | 3000 | 330.0 | 12.4 | 3.3 | 3.3 | 1.1 | 8.0 | 12.0 | Q2 |
| THS4520RGTT | VQFN | RGT | 16 | 250 | 180.0 | 12.4 | 3.3 | 3.3 | 1.1 | 8.0 | 12.0 | Q2 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| THS4520RGTR | VQFN | RGT | 16 | 3000 | 353.0 | 353.0 | 32.0 |
| THS4520RGTT | VQFN | RGT | 16 | 250 | 213.0 | 191.0 | 35.0 |



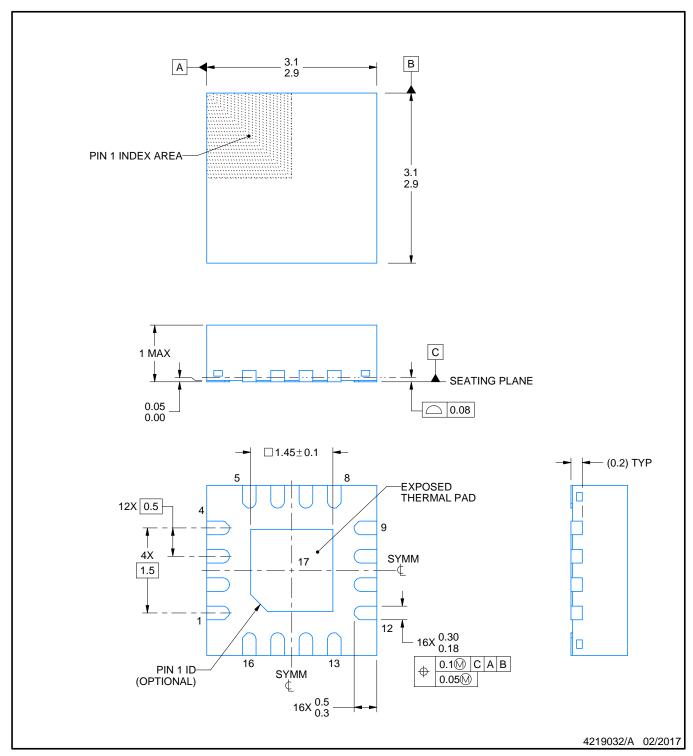
Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.







PLASTIC QUAD FLATPACK - NO LEAD

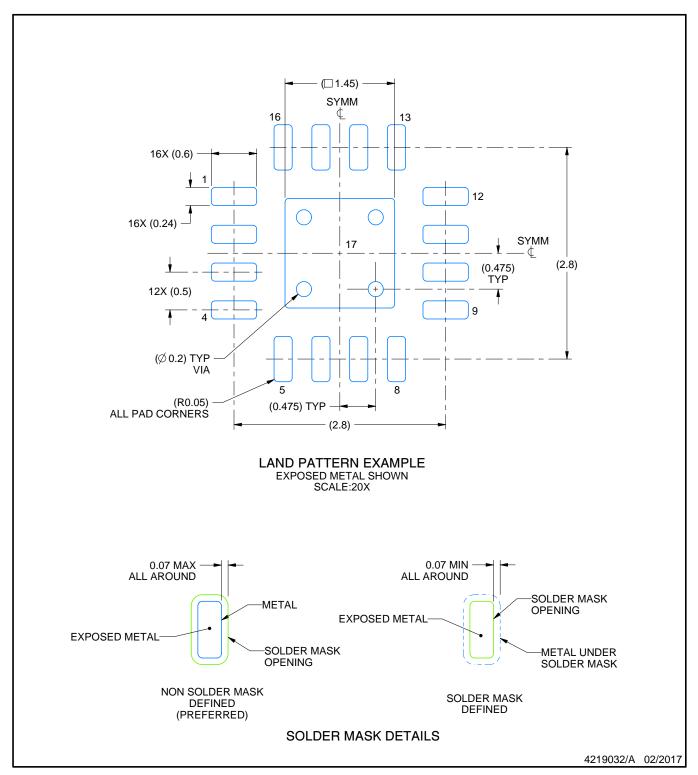


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 2. This drawing is subject to change without notice.
- The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.
 Reference JEDEC registration MO-220



PLASTIC QUAD FLATPACK - NO LEAD

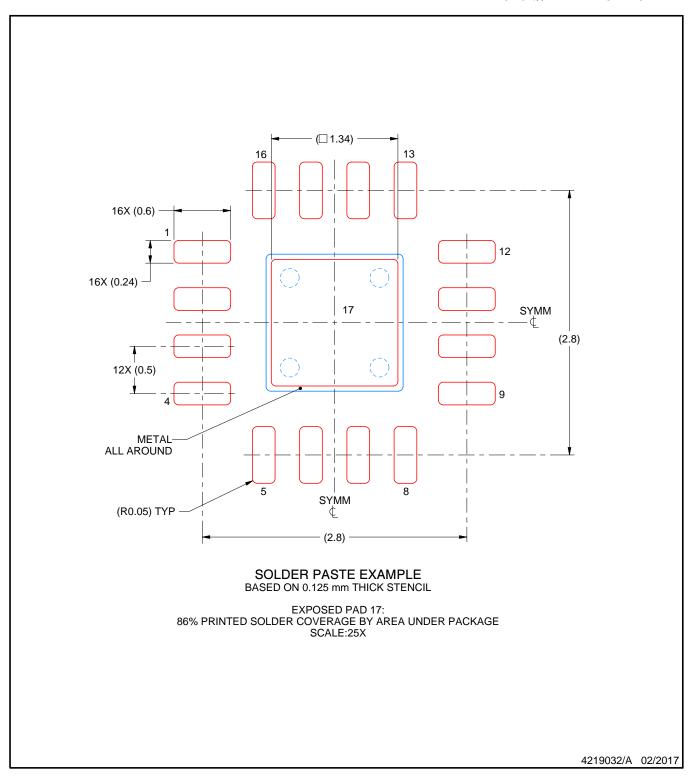


NOTES: (continued)

- 5. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 6. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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